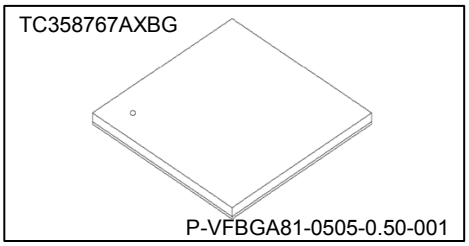
CMOS Digital Integrated Circuit Silicon Monolithic

TC358767AXBG

Mobile Peripheral Devices



Weight: 44.0 mg (Typ.)

Overview

TC358767AXBG is a bridge device that enables video streaming from a Host (application or baseband processor) over MIPI DSI or DPI link to drive DisplayPort display panels. TC358767AXBG also supports audio streaming from the host via I2S interface to the Display panels. TC358767AXBG provides a low power bridge solution to efficiently translate MIPI DSI or DPI transfers to DisplayPort transfers. As the DisplayPort uses fewer wires compared to other existing display panel standards, it simplifies the LCD connectivity. The effect of using TC358767AXBG is to enable existing baseband devices supporting DSI or DPI streaming to connect to new panels supporting DisplayPort interface and also to connect to existing panels over longer distance using DisplayPort adaptors at far-end. TC358767AXBG can interface to up to two independent devices.

Features

- Translates MIPI DSI/DPI Link video stream from Host to DisplayPort Link data to external display devices.
- The inputs are driven by a DSI Host with 4-Data Lanes, upto1 Gbps/lane or DPI Host with 16/18/24 bit interface upto154 MHz parallel clock.
- Supports HDCP Digital Content Protection version 1.3 (DisplayPort amendment Rev1.1).
- Embeds audio information from the I2S port into the DisplayPort data stream.
- The output Interface consists of a DisplayPort Tx with a 2-lane Main Link and AUX-Ch.
- Register Configuration: From DSI link or I^2C interface.
- Interrupt to host to inform any error status or status needing attention from Host.
- Internal test pattern (color bar) generator for DP o/p testing without any video (DSI/DPI) i/p.
- Debug/Test Port: I^2C Slave
- **DSI Receiver**
  - ✧ MIPI DSI: v1.01 / MIPI D-PHY: v0.90 Compliant.
  - ✧ Up to four (4) Data Lanes with Bi-direction support on Data Lane 0.
  - ✧ Maximum speed at 1 Gbps/lane.
  - ✧ Supports Burst as well as Non-Burst Mode Video Data.
    - Video data packets are limited to one row per Hsync period.
  - ✧ Supports video stream packets for video data transmission.
  - ✧ Supports generic long packets for accessing the chip's register set.
  - ✧ Video input data formats:
    - RGB-565, RGB-666 and RGB-888.
    - New DSI V1.02 Data Type Support: 16-bit YCbCr 422
  - ✧ Interlaced video mode is not supported.
- **DPI Receiver**
  - ✧ Up to 16 / 18 / 24 bit parallel data interface.
  - ✧ Maximum speed at 154 MPs (MPixel per sec).
  - ✧ Video input data formats: RGB-565, RGB-666 and RGB-888.
  - ✧ Only Progressive mode supported.
  - ✧ Shutdown support (can be used in non-DPI mode also).
- **I2S Audio Interface:** Supports one I2S port for audio streaming from the host to TC358767AXBG.
  - ✧ Supports slave mode (BCLK, LRCLK & over-sampling clock input from Host).
  - ✧ Supports sampling frequencies of 32, 44.1, 48, 88.2, 96, 176.4 & 192 kHz.
  - ✧ Supports up to 2 audio channels.
  - ✧ Supports 16, 18, 20 or 24bits per sample.
  - ✧ Optionally inserts IEC60958 status bits and preamble bits per channel.
- **DisplayPort Interface:** Supports a DisplayPort link from TC358767AXBG to display panels.
  - ✧ High speed serial bridge chip using VESA DisplayPort 1.1a Standard.
  - ✧ Supports one dual-lane DisplayPort port for high bandwidth applications
  - ✧ Support 1.62 or 2.7 Gbps/lane data rate with voltage swings @0.4, 0.6, 0.8 or 1.2 V
  - ✧ Support of pre-emphasis levels of 0, 3.5dB and

6dB.
- ✧ Supports Audio related Secondary Data Packets.
- ✧ AUX channel supported at 1 Mbps.
- ✧ HPD support through GPIO[0] based interrupts
- ✧ Enhanced mode supported for content protection.
- ✧ Support HDCP encryption Version 1.3 with DisplayPort amendment Revision 1.1.
- ✧ Secure ASSR (Alternate Scrambler Seed Reset) support for eDP panels
  - System designer connects ASSR_DisablePad to VSS to enable eDP panels and ASSR
  - Drive ASSR_DisablePad with an inner ring VDDS for using DP panels and disable ASSR
  - System software read Revision ID field, 0x0500[7:0]:
    - ➢ 0x01 indicates eDP panels are used, DPCD register bit 0x0010A[0] of eDP panel should be set
    - ➢ 0x03 assumes DP panels are connected, DPCD register bit 0x0010A[0] of DP panel should Not be set
- ✧ Stream Policy Maker is assumed handled by the Host (software/firmware).
  - Start Link training in response to HPD & read final Link training status
  - Configure DP link for actual video streaming & start video streaming
- ✧ Link Policy maker is assumed shared between the Host and TC358767AXBG chip.
  - In auto_correction = 0 mode, control link training
  - Initiate Display device capabilities read and configure TC358767AXBG accordingly.
- ✧ Video timing generation as per panel requirement.
- ✧ SSCG with to 30 kHz modulation to reduce EMI.
- ✧ Toshiba Magic Square algorithm – RGB666 18b produces RGB888 24b like quality (with up to 16-million colors).
- ✧ Built in PRBS7 Generator to test DisplayPort Link.

- **I^2C Interface:**
  - ✧ I^2C slave interface for chip register set access enabled using a boot-strap option.
  - ✧ I^2C compliant slave interface support for normal (100 kHz) and fast mode (400 kHz).

- **GPIO Interface:**
  - ✧ 2 bits of GPIO (shared with other digital logic).
  - ✧ Direction controllable by Host I^2C accesses.

- **Clock Source:**
  - ✧ DisplayPort clock source is from an external clock input or clock from DSI interface (13, 26, 19.2 or 38.4 MHz) – generates all internal & output clocks to interfacing display devices.
  - ✧ Built-in PLLs generate high-speed DisplayPort link clock requiring no external components. These PLLs are part of the DisplayPort PHY.
- Clock and power management support to achieve low power states.

- **Possible modes of Operation:**
  - ✧ MODE S21: TC358767AXBG uses DisplayPort Tx as single 2-lane DisplayPort link to interface to single DisplayPort display device. Video stream source is from MIPI DSI Host.
  - ✧ MODE P21: TC358767AXBG uses DisplayPort Tx as single 2-lane DisplayPort link to interface to single DisplayPort display device. Video stream source is from MIPI DPI Host.

- **Power supply inputs**
  - ✧ Core and MIPI D-PHY: 1.2 V ± 0.06 V
  - ✧ Digital I/O: 1.8 V ± 0.09 V
  - ✧ DisplayPort: 1.8 V ± 0.09 V
  - ✧ DisplayPort: 1.2 V ± 0.06 V

- **Power Consumptions (based on estimations)**
  - ✧ Power-down mode (DSI-Rx in ULPS, DP PHY & PLLs disabled, clocks stopped):
    - DSI Rx: 0.01 mW
    - DP PHY: 2.34 mW
    - PLL9: 0.01 mW
    - Core: 0.96 mW
    - Rest: 0.01 mW
  - ✧ Normal operation (1920 × 1080 resolution with DSI-Rx in 4-lane @925 Mbps per lane, DP PHY in dual lane link @2.7 Gbps per lane):
    - DSI Rx: 21.79 mW
    - DP PHY: 142.70 mW
    - PLL9: 2.42 mW
    - Core: 87.64 mW
    - IOs: 1.68 mW

- **Package**
  - 0.5mm ball pitch, 81 balls, 5 × 5 mm BGA package

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REFERENCES

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2. MIPI DPI, “MIPI Alliance Standard for Display Pixel Interface (DPI-2) Version 2.00 – 15 September 2005”
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7. I^2C bus specification, version 2.1, January 2000, Philips Semiconductor
8. Draft CEA-861-C, A DTV Profile for Uncompressed High Speed Digital Interfaces (Doc. Number: CEA-861rCv9.pdf (PNXXX)) Date: 05/04/2005
9. Display Port PHY DFT Strategy Specification Rev 1.3

1. Overview

The DSI/DPI to Display Port converter (TC358767AXBG) is a bridge device that enables video streaming from a Host (application or baseband processor) over MIPI DSI or DPI link to drive DisplayPort display panels. TC358767AXBG also supports audio streaming from the host via I2S interface to the Display panels. TC358767AXBG provides a low power bridge solution to efficiently translate MIPI DSI or DPI transfers to DisplayPort transfers. As the DisplayPort uses fewer wires compared to other existing display panel standards, it simplifies the LCD connectivity. The effect of using TC358767AXBG is to enable existing baseband devices supporting DSI or DPI streaming to connect to new panels supporting DisplayPort interface and also to connect to existing panels over longer distance using DisplayPort adaptors at far-end. TC358767AXBG can interface to up to two independent devices.

The chip can be configured through the DSI link by sending write/read register commands through DSI Generic Long Write packets. It can also be configured through the I^2C Slave interface.

The DSI-RX receiver supports from 1 to 4-Lane configurations at bit rate up to 1 Gbps per lane. Host can transmit video in continuous video streaming mode. Host controls video timing by sending video frame and line sync events together with video pixel data; video data transmission can be burst or non-burst. Since the chip integrates only a small video buffer, Host still has to take care of transmitting pixel data at appropriate video line time in order to avoid buffer overflow (or underflow).

The DPI-Rx receiver supports 16, 18 or 24 bits parallel interface along with the required control signals for the Pixel clock and HSync/VSync/DE.

The TC358767AXBG also supports content protection using HDCP copy protection.

The DisplayPort transmitter supports data throughput at 1.62 Gbps or 2.7 Gbps per lane of main link.

TC358767AXBG supports two configuration modes, MODE S21 and MODE P21. These modes mainly differ based on the source of input stream and number of display devices that TC358767AXBG can be connected to.

- Mode_S21: A system configuration where TC358767AXBG may typically be used is shown in
- Figure 1.1. In this configuration, the TC358767AXBG can support displays with resolution up to WUXGA (1920×1200) at 24bit, 60 fps or WUXGA (1920×1200) at 18bit, 60 fps. Video stream source is from DSI Host.
- Mode_P21: A system configuration where TC358767AXBG may typically be used is shown in Figure 1.2. This is similar to the Mode_S21 except that the video stream source is from DPI Host. In this configuration, the TC358767AXBG can support displays with resolution up to WUXGA (1920×1200) at 24bit, 60 fps.

The chip supports power management to conserve power when its functions are not in use. Host manages the chip's power consumption modes by using ULPS messages over DSI link or the shutdown pin (SD) during DPI input mode.

The following figures show all these modes, where TC358767AXBG, display panels and a Host are connected in target Reference system for mobile large display panel applications.

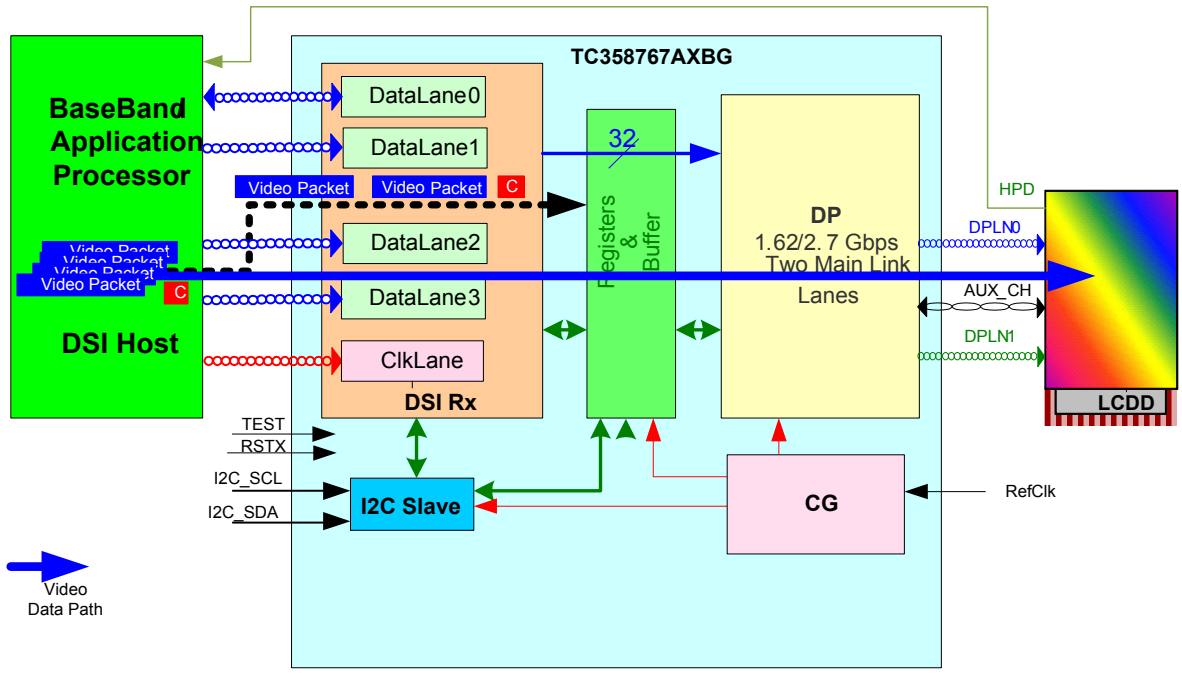

Figure 1.1 System Overview with TC358767AXBG in MODE_S21 Configuration

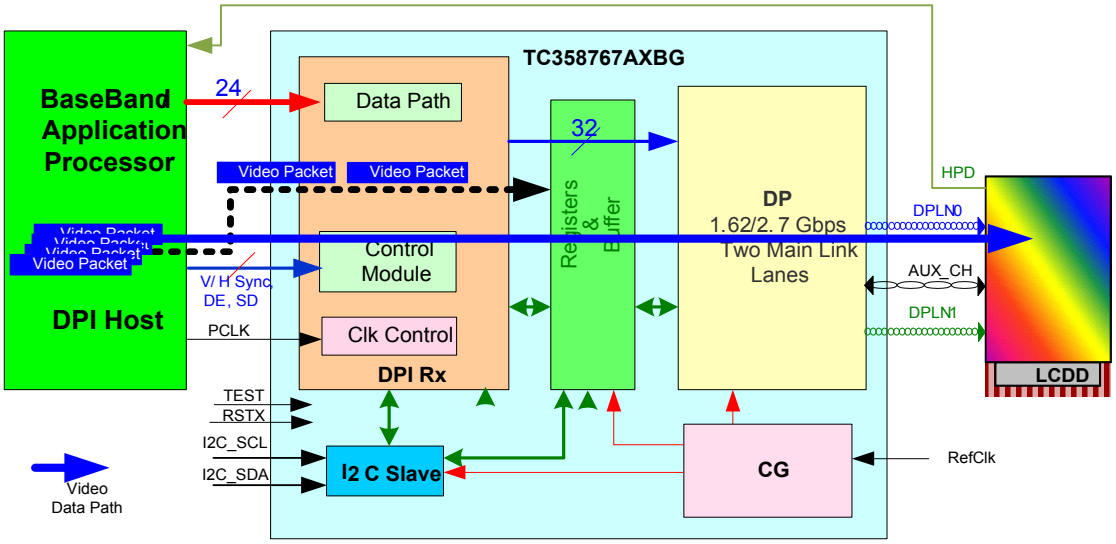

Figure 1.2 System Overview with TC358767AXBG in MODE_P21 Configuration

2. Features

Below are the main features supported by TC358767AXBG.

- Translates MIPI DSI/DPI Link video stream from Host to DisplayPort Link data to external display devices.
- The inputs are driven by a DSI Host with 4-Data Lanes, upto1 Gbps/lane or DPI Host with 16/18/24 bit interface upto154 MHz parallel clock.
- Supports HDCP Digital Content Protection version 1.3 (DisplayPort amendment Rev1.1).
- Embeds audio information from the I2S port into the DisplayPort data stream.
- The output Interface consists of a DisplayPort Tx with a 2-lane Main Link and AUX-Ch.
- Register Configuration: From DSI link or I^2C interface.
- Interrupt to host to inform any error status or status needing attention from Host.
- Internal test pattern (color bar) generator for DP o/p testing without any video (DSI/DPI) i/p.
- Debug/Test Port: I^2C Slave
- **DSI Receiver**
  - ✧ MIPI DSI: v1.01 / MIPI D-PHY: v0.90 Compliant.
  - ✧ Up to four (4) Data Lanes with Bi-direction support on Data Lane 0.
  - ✧ Maximum speed at 1 Gbps/lane.
  - ✧ Supports Burst as well as Non-Burst Mode Video Data.
    - Video data packets are limited to one row per Hsync period.
  - ✧ Supports video stream packets for video data transmission.
  - ✧ Supports generic long packets for accessing the chip's register set.
  - ✧ Video input data formats:
    - RGB-565, RGB-666 and RGB-888.
    - New DSI V1.02 Data Type Support: 16-bit YCbCr 422
  - ✧ Interlaced video mode is not supported.
- **DPI Receiver**
  - ✧ Up to 16 / 18 / 24 bit parallel data interface.
  - ✧ Maximum speed at 154 MPs (MPixel per sec).
  - ✧ Video input data formats: RGB-565, RGB-666 and RGB-888.
  - ✧ Only Progressive mode supported.
  - ✧ Shutdown support (can be used in non-DPI mode also).
- **I2S Audio Interface:** Supports one I2S port for audio streaming from the host to TC358767AXBG.
  - ✧ Supports slave mode (BCLK, LRCLK & over-sampling clock input from Host).
  - ✧ Supports sampling frequencies of 32, 44.1, 48, 88.2, 96, 176.4 & 192 kHz.
  - ✧ Supports up to 2 audio channels.
  - ✧ Supports 16, 18, 20 or 24 bits per sample.
  - ✧ Optionally inserts IEC60958 status bits and preamble bits per channel.
- **DisplayPort Interface:** Supports a DisplayPort link from TC358767AXBG to display panels.
  - ✧ High speed serial bridge chip using VESA DisplayPort 1.1a Standard.
  - ✧ Supports one dual-lane DisplayPort port for high bandwidth applications
  - ✧ Support 1.62 or 2.7 Gbps/lane data rate with voltage swings @0.4, 0.6, 0.8 or 1.2 V
  - ✧ Support of pre-emphasis levels of 0, 3.5 dB and 6 dB.
  - ✧ Supports Audio related Secondary Data Packets.
  - ✧ AUX channel supported at 1 Mbps.
  - ✧ HPD support through GPIO[0] based interrupts
  - ✧ Enhanced mode supported for content protection.
  - ✧ Support HDCP encryption Version 1.3 with DisplayPort amendment Revision 1.1.
  - ✧ Secure ASSR (Alternate Scrambler Seed Reset) support for eDP panels
    - System designer connects ASSR_DisablePad to VSS to enable eDP panels and ASSR
    - Drive ASSR_DisablePad with an inner ring VDDS for using DP panels and disable ASSR
    - System software read Revision ID field, 0x0500[7:0]:
      - ➢ 0x01 indicates eDP panels are used, DPCD register bit 0x0010A[0] of eDP panel should be set

- 0x03 assumes DP panels are connected, DPCD register bit 0x0010A[0] of DP panel should Not be set

✧ Stream Policy Maker is assumed handled by the Host (software/firmware).
  - Start Link training in response to HPD & read final Link training status
  - Configure DP link for actual video streaming & start video streaming

✧ Link Policy maker is assumed shared between the Host and TC358767AXBG chip.
  - In auto_correction = 0 mode, control link training
  - Initiate Display device capabilities read and configure TC358767AXBG accordingly.

✧ Video timing generation as per panel requirement.
✧ SSCG with to 30 kHz modulation to reduce EMI.
✧ Toshiba Magic Square algorithm – RGB666 18b produces RGB888 24b like quality (with up to 16-million colors).
✧ Built in PRBS7 Generator to test DisplayPort Link.

- **I^2C Interface:**
  ✧ I^2C slave interface for chip register set access enabled using a boot-strap option.
  ✧ I^2C compliant slave interface support for normal (100 kHz) and fast mode (400 kHz).
- **GPIO Interface:**
  ✧ 2 bits of GPIO (shared with other digital logic).
  ✧ Direction controllable by Host I^2C accesses.
- **Clock Source:**
  ✧ DisplayPort clock source is from an external clock input or clock from DSI interface (13, 26, 19.2 or 38.4 MHz) – generates all internal & output clocks to interfacing display devices.
  ✧ Built-in PLLs generate high-speed DisplayPort link clock requiring no external components. These PLLs are part of the DisplayPort PHY.
- Clock and power management support to achieve low power states.
- **Possible modes of Operation:**
  ✧ MODE S21: TC358767AXBG uses DisplayPort Tx as single 2-lane DisplayPort link to interface to single DisplayPort display device. Video stream source is from MIPI DSI Host.
  ✧ MODE P21: TC358767AXBG uses DisplayPort Tx as single 2-lane DisplayPort link to interface to single DisplayPort display device. Video stream source is from MIPI DPI Host.
- **Power supply inputs**
  ✧ Core and MIPI D-PHY: 1.2 V ± 0.06 V
  ✧ Digital I/O: 1.8 V ± 0.09 V
  ✧ DisplayPort: 1.8 V ± 0.09 V
  ✧ DisplayPort: 1.2 V ± 0.06 V

- **Power Consumptions (based on estimations)**
  - ✧ Power-down mode (DSI-Rx in ULPS, DP PHY & PLLs disabled, clocks stopped):
    - DSI Rx: 0.01 mW
    - DP PHY: 2.34 mW
    - PLL9: 0.01 mW
    - Core: 0.96 mW
    - Rest: 0.01 mW
  - ✧ Normal operation (1920×1080 resolution with DSI-Rx in 4-lane @925 Mbps per lane, DP PHY in dual lane link @2.7 Gbps per lane):
    - DSI Rx: 21.79 mW
    - DP PHY: 142.70 mW
    - PLL9: 2.42 mW
    - Core: 87.64 mW
    - IOs: 1.68 mW
- **Package**
  - 0.5mm ball pitch, 81 balls, 5 × 5 mm BGA package

Note: Attention about ESD. This product is weak against ESD. Please handle it carefully.

Table 2.1 TC358767AXBG operational modes summary with panel size support information

Mode	Input Configuration		Register Access Method	Max Panel size example
	DSI input	DPI input		
S21	Active	X	DSI or I^2C	WUXGA 18bpp @ 60fps WUXGA 24bpp @ 60fps
P21	X	Active	I^2C	WUXGA 24bpp @ 60fps

Tables below provide an idea of different panel sizes that can be supported by using different data link lane configurations.

Table 2.2 Panel Size v/s Data link required by TC358767AXBG in DSI input case

Frame Size			FPS	Pixel Clock (MHz)	RGB666				RGB888			
		With OverHead			Bit Rate (Gbps)	# DSI Data lanes	# DP Main links		Bit Rate (Gbps)	# DSI Data lanes	# DP Main links	
							1.62G	2.7G			1.62G	2.7G
XGA	1024×768	1184×790	60	56	1.01	2	1	1	1.34	2	2	1
WXGA+	1366×768	1526×790	60	72	1.30	2	2	1	1.74	2	2	1
WXGA+ / WSXGA	1440×900	1600×926	60	89	1.60	2	2	1	2.13	3	2	1
SXGA+	1400×1050	1560×1080	60	89	1.82	2	2	1	2.43	3	2	2
WSXGA+	1680×1050	1840×1080	60	119	2.15	3	2	1	2.86	3	–	2
UXGA	1600×1200	1760×1235	60	130	2.35	3	2	2	3.13	4	–	2
WUXGA	1920×1200	2080×1235	60	154	2.77	3	–	2	3.70	4	–	2

Table 2.3 Panel Size v/s Data link required by TC358767AXBG in DPI input case

Frame Size			FPS	Pixel Clock (MHz)	DPI Support 154 MHz PCLK	RGB666			RGB888		
		With OverHead				Bit Rate (Gbps)	# DP Main links		Bit Rate (Gbps)	# DP Main links	
							1.62G	2.7G		1.62G	2.7G
XGA	1024×768	1184×790	60	56	Yes	1.01	1	1	1.34	2	1
WXGA+	1366×768	1526×790	60	72	Yes	1.30	2	1	1.74	2	1
WXGA+ / WSXGA	1440×900	1600×926	60	89	Yes	1.60	2	1	2.13	2	1
SXGA+	1400×1050	1560×1080	60	89	Yes	1.82	2	1	2.43	2	2
WSXGA+	1680×1050	1840×1080	60	119	Yes	2.15	2	1	2.86	–	2
UXGA	1600×1200	1760×1235	60	130	Yes	2.35	2	2	3.13	–	2
WUXGA	1920×1200	2080×1235	60	154	Yes	2.77	–	2	3.70	–	2

Note: These are the formats commonly used by displays. Support for other sizes is possible as long as they satisfy the maximum data rate constraints on the DSI and DisplayPort link interfaces.

NOTE: Throughout the rest of the document, "DP" is used to denote "DisplayPort". Both these words have been used interchangeably and refer to the VESA DisplayPort specification as mentioned in the references.

3. External Pins

3.1. TC358767AXBG External Pins

TC358767×AXBG uses an 81pin package. Following table gives the signals of TC358767AXBG and their function.

Table 3.1 TC358767AXBG Functional Signal List for 81-pin Package

Group	Pin Name	I/O	Type	Function	Note
System: Reset & Clock (9)	RESX	I	Sch	System Reset – active Low	
	REFCLK	I	Sch	13, 26, 19.2 or 38.4 MHz 50ps phase jitter p2p/ WC duty cycle 40-60%	
	TEST	I	N	Test Pin, active high	
	TEST[3]	O	N	Test Pin, Open	
	INT	O	N	Interrupt to Host	4mA
	SD	I	N	Shutdown Input	
	DISABLE_ASSR	I	N	1: Disable ASSR, set when connecting to DP panels 0: Enable ASSR for eDP panel application	
	MODE[1:0]	I	N	Mode Selection pins	
DSI Rx (10)	DSICP	I	MIPI-PHY	MIPI-DSI Rx Clock Lane Pos	
	DSICM	I	MIPI-PHY	MIPI-DSI Rx Clock Lane Neg	
	DSIDP[3:0]	I/O	MIPI-PHY	MIPI-DSI Rx Data Lane Pos	
	DSIDM[3:0]	I/O	MIPI-PHY	MIPI-DSI Rx Data Lane Neg	
DP Out (8)	DPLNP[1:0]	O	DP-PHY	eDP Output Main Link Pos	
	DPLNM[1:0]	O	DP-PHY	eDP Output Main Link Neg	
	DPAUXP[0]	I/O	DP-PHY	eDP Output AUX Channel Pos	
	DPAUXM[0]	I/O	DP-PHY	eDP Output AUX Channel Neg	
	PREC_RES[1:0]	I	DP-PHY	Precision Resistance (3K @ 1%) connection	
DPI Rx (28)	DPI_PCLK	I/O	N	DPI Pixel Clock (max 154 MHz) (default: Input)	4mA
	DPI_VSYNC	I/O	N	DPI Vertical Sync (default: Input)	4mA
	DPI_HSYNC	I/O	N	DPI Horizontal Sync (default: Input)	4mA
	DPI_DE	I/O	N	DPI Data Enable (default: Input)	4mA
	DPI_D [23:0]	I/O	N	DPI Parallel Data (default: Input)	4mA
I2C (3)	I2C_SCL	OD	FS/Sch	I^2C Clock	
	I2C_SDA	OD	FS/Sch	I^2C Data	4mA
	I2C_ADR_SEL	I	N	I^2C Slave Address Select	
I2S (3)	I2S_BCLK	I	N	I2S Bit Clock (max 12.5 MHz)	
	I2S_LRCLK	I	N	I2S sample clock (max 192 kHz)	
	I2S_DATA	I	N	I2S Data	
GPIO (2)	GPIO[1:0]	OD	5T-OD	GPIO or Test Control*Note1 GPIO[1:0] can be used for HPD support	4mA
POWER (11)	VDDC (VDD12)	NA		VDD for Internal Core (2)	
	VDDS (1.8V)	NA		VDDS for IO Ring power supply (1)	
	VDD_PLL18 (1.8V)	NA		VDD for DP PHY PLLs (1)	
	VDD_PLL12 (1.2V)	NA		VDD for DP PHY PLLs(1)	
	VDD_DP18 (1.8V)	NA		VDD for DP PHY Main Channels (2)	
	VDD_PLL912(1.2V)	NA		VDD for PLL9 (1)	
	VDD_DP12 (1.2V)	NA		VDD for DP PHY (1)	
	VDD_DSI12 (1.2V)	NA		VDD for the MIPI DSI PHY (1)	
	VPGM	NA		eFUSE programming voltage (1)	
GROUND (7)	VSS	NA		Ground (including VSSC (core), VSS_IO (IO), VSS_DSI (MIPI), VSS_DP (DP))	

Total 81 pins TC358767AXBG BGA package.

Note 1: Pins with multiplexed Functional mode functions

N: Normal IO FS: Fail safe IO – gated

PHY: Either DP analog front end or MIPI D-PHY Sch: Schmitt trigger input

OD: Open drain 5T-OD: 5 V tolerant bi-direction buffer with Open drain

Pd: Pull Down

3.2. TC358767AXBG Pin Mapping

The mapping of TC358767AXBG signals to the external pins is given in the following figure. (BGA array)

Top View (through the die)

A1 DSIDM_0	**A2** DSIDP_0	**A3** I2S_LRCLK	**A4** VDDC	**A5** VDDC	**A6** INT	**A7** VDDS	**A8** I2C_SDA	**A9** I2C_SCL
B1 DSIDM_1	**B2** DSIDP_1	**B3** GPIO_0	**B4** I2S_BCLK	**B5** I2S_DATA	**B6** MODE_0	**B7** MODE_1	**B8** GPIO_1	**B9** I2C_ADR_SEL
C1 DSICM	**C2** DSICP	**C3** DPI_DE	**C4** DPI_VSYNC	**C5** DPI_D_5	**C6** DPI_D_7	**C7** DPI_D_10	**C8** TEST_3	**C9** SD
D1 VDD_DSI12	**D2** VSS_DSI	**D3** DPI_HSYNC	**D4** DPI_D_0	**D5** VSS	**D6** DPI_D_9	**D7** DPI_D_12	**D8** DPI_D_13	**D9** DSI_D_14
E1 DSIDM_2	**E2** DSIDP_2	**E3** DPI_D_1	**E4** DPI_D_3	**E5** VSS	**E6** VSS	**E7** DPI_D_16	**E8** VPGM	**E9** DPI_D_11
F1 DSIDM_3	**F2** DSIDP_3	**F3** DPI_D_2	**F4** DPI_D_6	**F5** DPI_D_8	**F6** DPI_D_15	**F7** DPI_D_18	**F8** DPI_D_17	**F9** DPI_D_20
G1 PREC_RES_0	**G2** Disable_ASSR	**G3** DPI_D_4	**G4** TEST	**G5** DPI_D_19	**G6** DPI_PCLK	**G7** DPI_D_21	**G8** DPI_D_23	**G9** DPI_D_22
H1 PREC_RES_1	**H2** VSS_DP	**H3** DPLNP_0	**H4** VDD_DP12	**H5** VSS_DP	**H6** DPLNP_1	**H7** VSS_DP	**H8** DPAUXP_0	**H9** VDD_PLL912
J1 REFCLK	**J2** VDD_DP18	**J3** DPLNM_0	**J4** VDD_PLL12	**J5** VDD_PLL18	**J6** DPLNM_1	**J7** VDD_DP18	**J8** DPAUXM_0	**J9** RESX

Figure 3.1 TC358767AXBG 81-Pin Layout

Table 3.2 Mechanical Dimension of TC358767AXBG BGA

Package	Solder Ball Pitch	Solder Ball Height	Package Dimension	Package Height	Note
81-Pin	0.5 mm	0.25 mm	5.0 × 5.0 mm^2	1.0 mm	

4. Package

The package for TC358767AXBG is described in the figure below.

P-VFBGA81-0505-0.50-001 "Unit:mm"

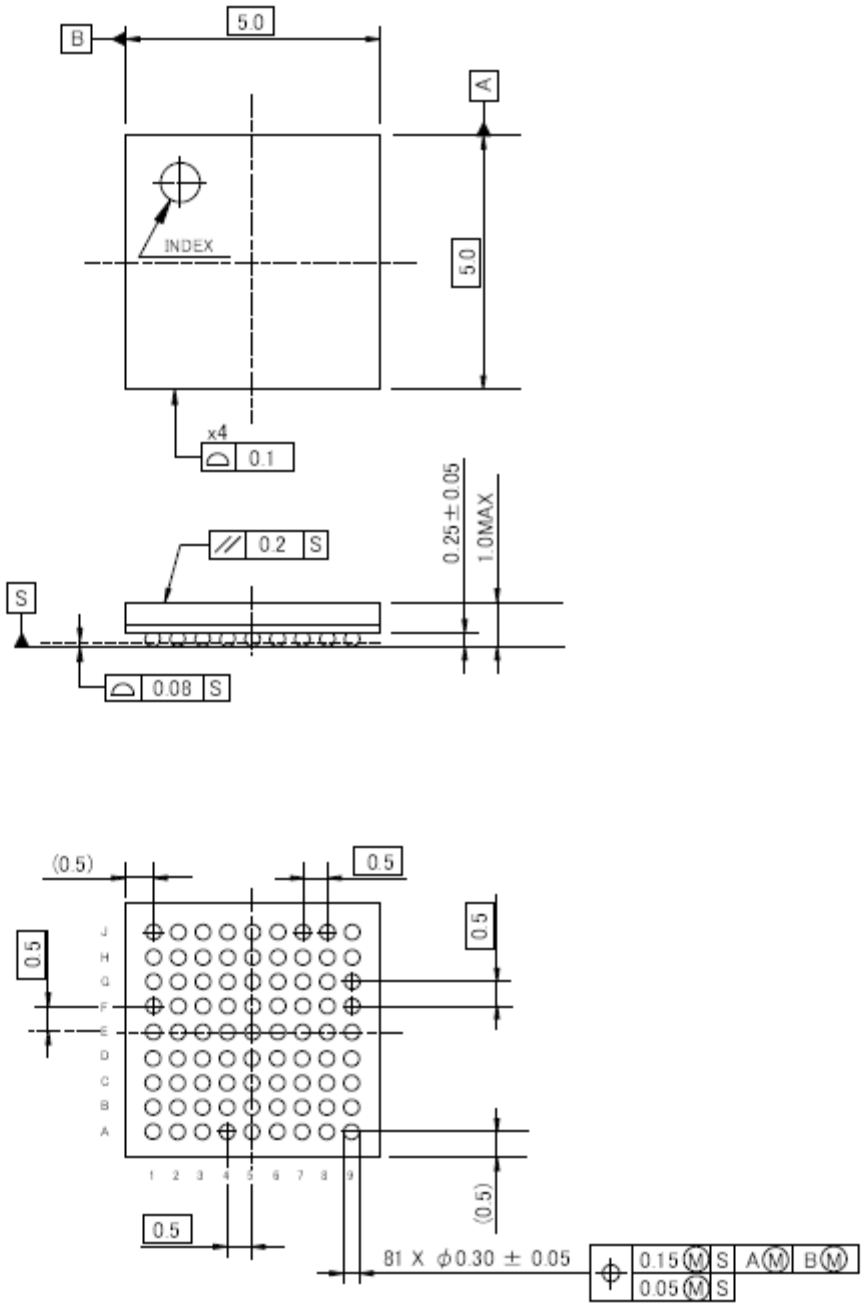

Figure 4.1 81 pin TC358767AXBG package

Weight: 44.0 mg (Typ.)

The mechanical dimension of BGA81 package is listed below.

Table 4.1 Mechanical Dimension of P-VFBGA81-0505-0.50-001

Package	Solder Ball Pitch	Solder Ball Height	Package Dimension	Package Height	Note
81-Pin	0.50 mm	0.25 mm	5.0 × 5.0 mm^2	1.0 mm	

5. Electrical Characteristics

5.1. Absolute Maximum Ratings

VSS= 0 V reference

VDD18 used for VDDS as well as VDD-DP18; VDD12 used for VDDC as well as VDD-DSI12

Parameter	Symbol	Rating	Unit
Supply voltage (1.8 V)	VDD18	-0.3 to +3.5	V
Supply voltage (1.2 V)	VDD12	-0.3 to +2.0	V
Supply voltage (IO)	VDD18	-0.3 to +3.5	V
	VREF	-0.3 to +3.5	V
Input voltage	VIN	-0.3 to VDDS+0.3	V
Output voltage	VOUT	-0.3 to VDDS+0.3	V
Storage temperature	Tstg	-40 to +125	°C

5.2. Operating Condition

VSS= 0 V reference

VDD18 used for VDDS as well as VDD-DP18; VDD12 used for VDDC as well as VDD-DSI12

Parameter	Symbol	Min	Typ.	Max	Unit
Supply voltage (1.8 V)	VDD18	1.71	1.8	1.89	V
Supply voltage (1.2 V)	VDD12	1.14	1.2	1.26	V
Operating frequency (internal)	Fopr	-	-	200	MHz
Operating temperature	Ta	-20	-	+85	°C

5.3. DC Electrical Specification

VSS=VSS_C=VSS_IO=VSS_DSI=VSS_DP=VSS_PLL=VSS_REG=0V reference

Parameter	Symbol	Min	Typ.	Max	Unit
Input voltage High level CMOS input Note1	VIH	0.7 VDDS		VDDS	V
Input voltage Low level CMOS input Note1	VIL	0		0.3 VDDS	V
Input voltage High level CMOS Schmitt Trigger Note1	VIHS	0.7 VDDS		VDDS	V
Input voltage Low level CMOS Schmitt Trigger Note1	VILS	0		0.3 VDDS	V
Output voltage High level Note1, Note2	VOH	0.8 VDDS		VDDS	V
Output voltage Low level Note1, Note2	VOL	0		0.2 VDDS	V
Input leak current High level	IIH1 (Note3)	-10	-	10	μA
Input leak current Low level	IIL1 (Note4)	-10	-	10	μA
	IIL2 (Note5)	-200	-	-10	μA

Note1: VDDS within recommended operating condition.

Note2: Output current value is according to each IO buffer specification. Output voltage changes with output current value.

Note3: Normal pin, or Pull-up I/O pin applied VDD18_IO supply voltage to input pin

Note4: Normal pin applied VSS (0 V) to input pin

Note5: Pull-up I/O pin applied VSS (0 V) to input pin

5.4. Power Consumption

Power consumption as measured for the power-down modes and for normal operation are provided below:

- Power-down mode (DSI-Rx in ULPS, DP PHY & PLLs disabled, clocks stopped):
  - ✧ DSI Rx: 0.01 mW
  - ✧ DP PHY: 2.34 mW
  - ✧ PLL9: 0.01 mW
  - ✧ Core: 0.96 mW
  - ✧ Rest: 0.01 mW

- Normal operation (1920×1080 resolution with DSI-Rx in 4-lane @925 Mbps per lane, DP PHY in dual lane link @2.7 Gbps per lane):
  - ✧ DSI Rx: 21.79 mW
  - ✧ DP PHY: 142.70 mW
  - ✧ PLL9: 2.42 mW
  - ✧ Core: 87.64 mW
  - ✧ IOs: 1.68 mW

6. Revision History

Table 6.1 Revision History

Revision	Date	Description
0.97	2014-04-10	Newly released

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